

# Global Semiconductor Equipment Market Research 2011- 2022

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## Abstracts

### Summary

Semiconductor equipment plays a vital role in the manufacturing of integrated devices (I.C.s) are typically located in a manufacturing facility called a fab.

The Global Semiconductor Equipment market is estimated to reach 42.3 Billion USD in 2017. On the basis of region, Taiwan is the largest market segment of Semiconductor Equipment, followed by Korea and North America. In the report, HeyReport says Wafer Processing dominates the largest Application share in 2017. The objective of report is to define, segment, and project the market on the basis of type, application, and region, and to describe the content about the factors influencing market dynamics, policy, economic, technology and market entry etc.

Based on products type, the report describes major products type share of regional market. Products mentioned as follows:

By Type

Assembly and Packaging Equipment

Test Equipment

Wafer Processing Equipment

Based on region, the report describes major regions market by products and

application. Regions mentioned as follows:

Taiwan

Korea

North America

China

Japan

Europe

Based on Application, the report describes major Application share of regional market. Application mentioned as follows:

Wafer Processing

Testing

Packaging

Leading vendors in the market are included based on profile, business performance etc. Vendors mentioned as follows:

Applied Materials

Lam Research

ASML

Tokyo Electron

KLA-Tencor

Screen Semiconductor Solutions

Hitachi High-Technologies

Nikon

ASM International

Hitachi Kokusai

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